THIN FILM SURFACE MOUNT

Low Pass Filter

ALF-7300+

50Ω DC to 7.3 GHz

KEY FEATURES

- Low Passband Insertion Loss of 0.7 dB Typ.
- High Rejection of 39 dB Typ.
- Good Return Loss of 15 dB Typ.
- Small Size, 5.59 x 8.13 x 2.03 mm



Generic photo used for illustration purposes only

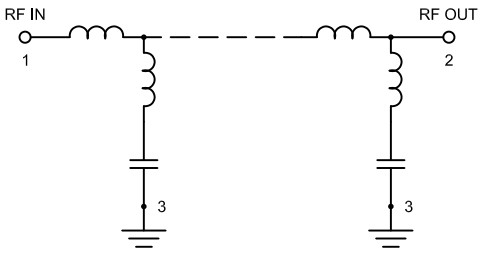
APPLICATIONS

- Wi-Fi 6E
- Test and Measurement Equipment

PRODUCT OVERVIEW

Mini-Circuits' Surface Mount Thin-Film filters offer low insertion loss and high rejection realized via Thin-Film on Alumina substrate, using a sputtering process that can guarantee an enhanced Q and repeatable performance. Low pass, high pass, and bandpass surface mount thin-film designs can be realized with this technology up to 40 GHz in a small form factor helping customers achieve their SWaP objectives. Using our high quality thin-film manufacturing process we can guarantee repeatability on large batches of filters.

FUNCTIONAL DIAGRAM



ELECTRICAL SPECIFICATIONS[1,2,3] AT +25°C

Parameter		F#	Frequency (GHz)	Min.	Typ.	Max.	Units
Passband	Insertion Loss	DC-F1	DC - 7.3	—	0.7	1.6	dB
	Freq. Cut-Off[4]	Fc	8.2	—	3	—	dB
	Return Loss	DC-F1	DC - 7.3	—	15	—	dB
Stopband	Rejection	F2-F3	9.4 - 10	25	37	—	dB
		F3-F4	10 - 16	33	39	—	
		F4-F5	16 - 18	—	20	—	

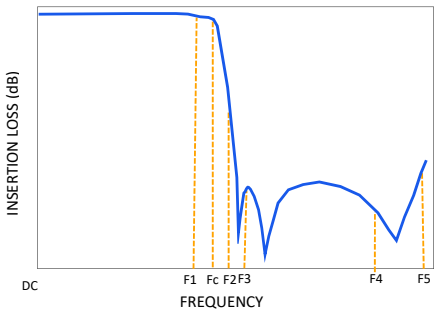
1. Tested in Evaluation Board P/N TB-ALF-7300+ with feedline losses removed by normalization of S12 and S21 traces to mesurement of TB thru-line.
2. This filter is bi-directional RF1 and RF2 ports may be interchanged, see S-Parameters for actual performance.
3.This filter can handle a DC of 100 mA.
4. Typical variation ±3%

ABSOLUTE MAXIMUM RATINGS[5]

Parameter	Ratings
Operating Temperature	-55 °C to +125 °C
Storage Temperature	-55 °C to +125 °C
Input Power[6]	10.75 W Max. at 25°C

5. Permanent damage may occur if any of these limits are exceeded.
6. Power rating applies only to signals within the passband. Derated power at +125°C is 5.2 W.

TYPICAL FREQUENCY RESPONSE



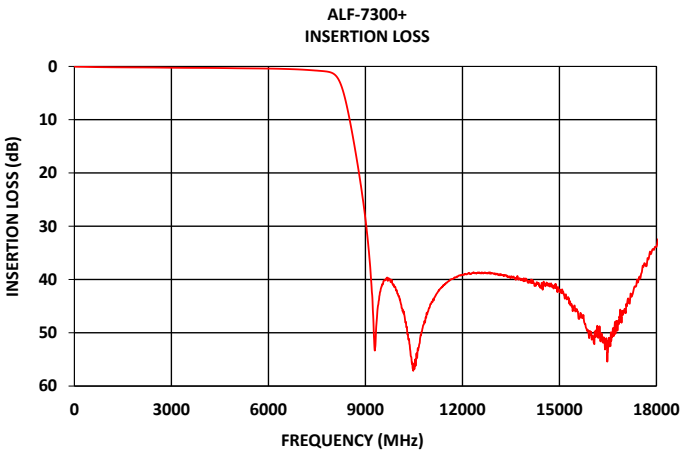
REV. OR
ECO-024893
ALF-7300+
EDU4856
URJ
250318

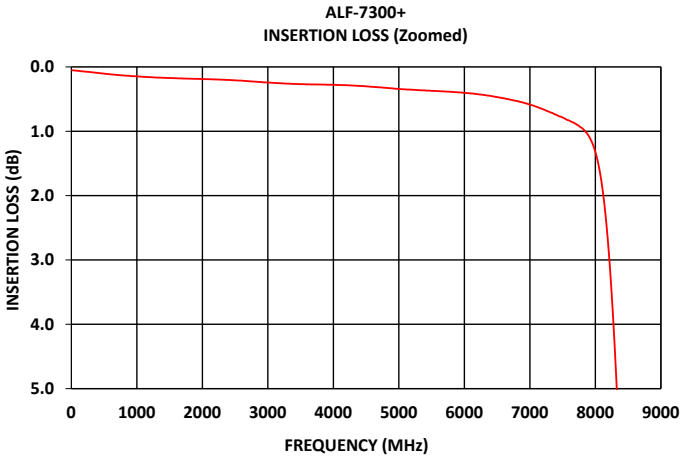
Low Pass Filter

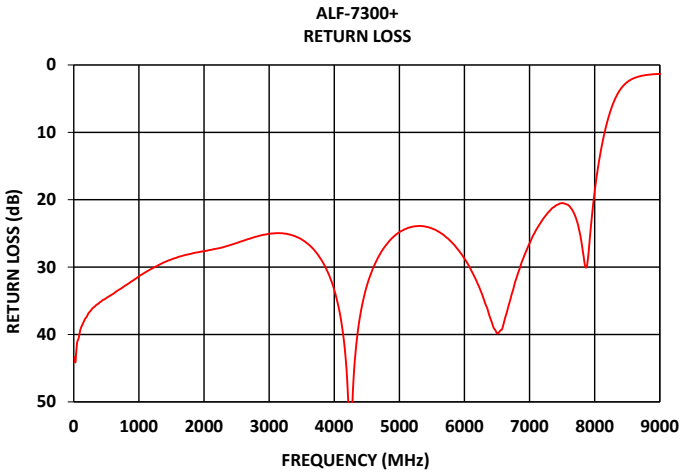
ALF-7300+

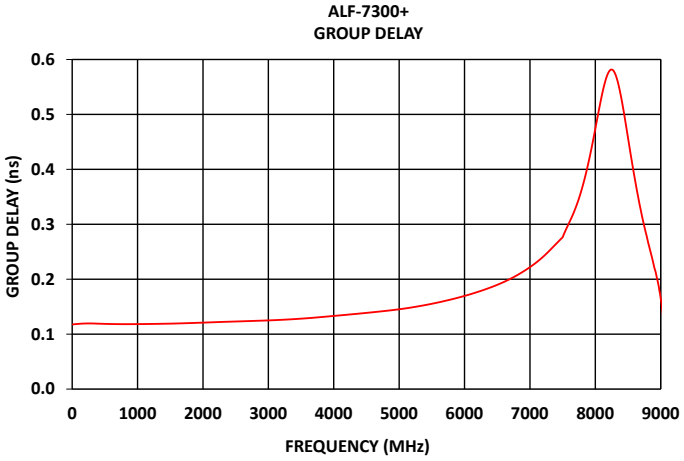
50Ω DC to 7.3 GHz

TYPICAL PERFORMANCE GRAPHS AT +25°C









THIN FILM SURFACE MOUNT

Low Pass Filter

ALF-7300+

50Ω DC to 7.3 GHz

FUNCTIONAL DIAGRAM

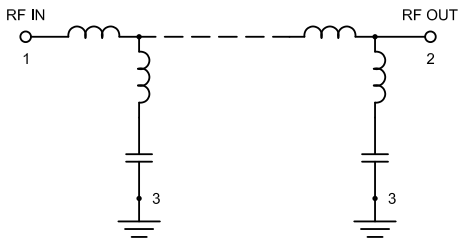
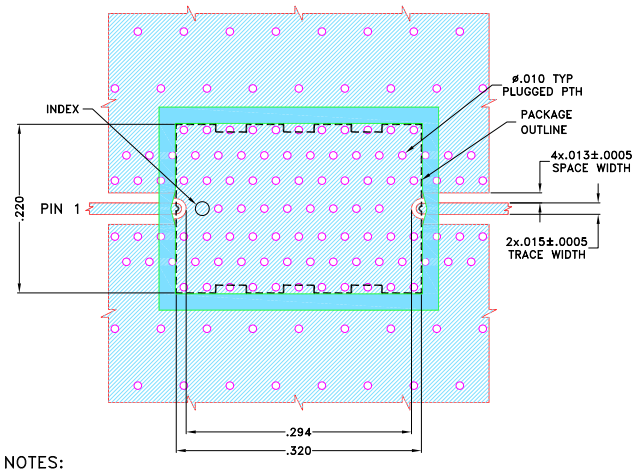


Figure 1. ALF-7300+ Functional Diagram

PAD DESCRIPTION

Function	Pad Number	Description
RF1[2]	1	Connects to RF Input Port
RF2[2]	2	Connects to RF Output Port
GROUND	3	Connects to Ground on PCB, (See drawing PL-764)
NC	—	No connection, not used internally. See drawing PL-764 for connection to PCB

SUGGESTED PCB LAYOUT (PL-764)

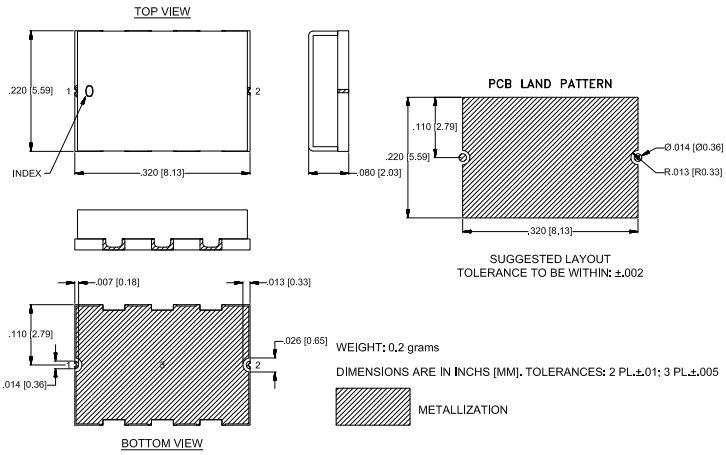


NOTES:
1. COPLANAR WAVEGUIDE PARAMETERS ARE SHOWN FOR ROGERS (RO4350B Lo Pro) WITH DIELECTRIC THICKNESS .0073±.0007. COPPER: 1/2 Oz. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER PATTERN WITH SMOBC (SOLDER MASK OVER BARE COPPER)
DENOTES PCB COPPER PATTERN FREE OF SOLDERMASK

Figure 2. Suggested PCB Layout PL-764

CASE STYLE DRAWING



PRODUCT MARKING*: ALF-7300

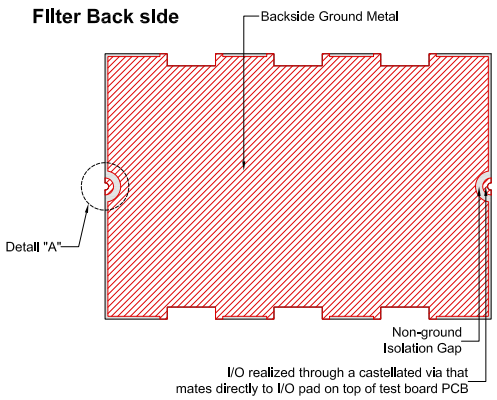
*Marking may contain other features or characters for internal lot control.

Low Pass Filter

ALF-7300+

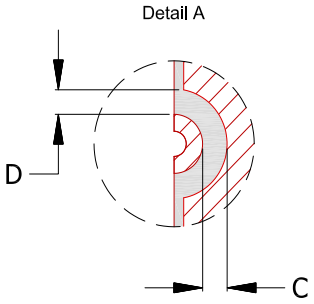
50Ω DC to 7.3 GHz

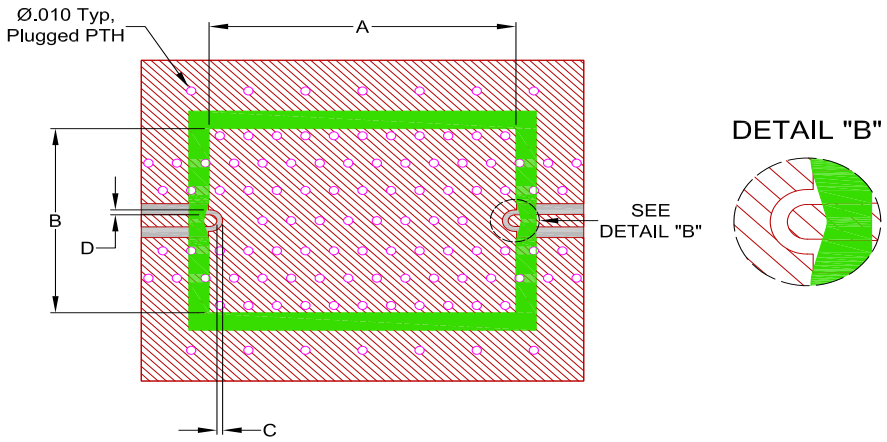
RECOMMENDED PCB LAYOUT PATTERN FOR FILTER



PCB Pattern Recommendations

Filter RF I/O Detail
(Filter Back Side)





1) Customer PCB's ground pattern length (dimension A) can be similar to filter length.
2) Customer PCB's ground pattern width (dimension B) can be similar filter width.
3) Dimensions C and D on Filter RF I/O detail and Customer PCB pattern can be closely match. The dimensions of C and D on the Customer PCB pattern can be slightly larger to account for component alignment tolerance (ground metal can be pulled back from RF I/O trace).
4) Recommend to use Solder mask at Customer PCB at outer area of filter pattern/ footprint with a clearance of about 1.25mil at each side. (Tighter registration tolerance required for solder mask)
5) Recommended to use Solder mask at I/O of Customer PCB as per above diagram (refer detail B).

Low Pass Filter

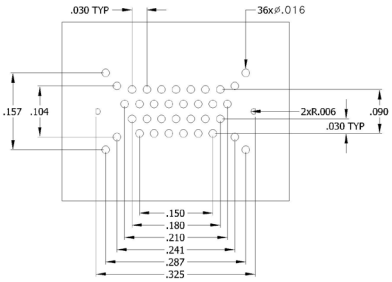
ALF-7300+

50Ω DC to 7.3 GHz

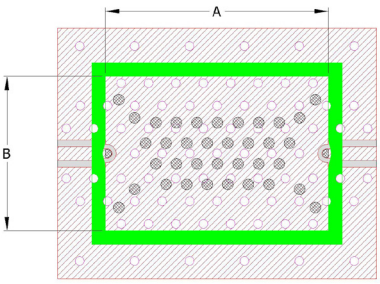
COMMENTS ON COMPONENT HANDLING AND SOLDER ATTACH

1) Avoid using soldering iron directly to the ceramic filter. This would lead to development of crack in the component due to thermal shock.
2) Vacuum pick-up tool or plastic tweezers are recommended for handling the components. Extra care should be taken not to scratch the filter or metal area.
3) Use 2-3 mil thickness stencil plate and screen print the solder. Refer below picture for recommended stencil pattern to get the best solder attachment.

Stencil opening drawing



Solder location after screen print



4) Plugged ground vias in the PWB will improve attachment consistency.
5) Recommended to have a similar or closer test board material and thickness (refer Mini-Circuits evaluation board for details) to minimize the CTE over the temperature range.

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ADDITIONAL DETAILED INFORMATION IS AVAILABLE ON OUR DASH BOARD. CLICK HERE

Performance Data and Graphs	Data Graphs S-Parameter (S2P Files) Data Set (.zip file) De-embedded to device pads
Case Style	UC2731 Lead Finish: Gold over Nickel Plate.
RoHS Status	Compliant
Tape and Reel	TR-F003
Suggested Layout for PCB Design	PL-764
Evaluation Board	TB-ALF-7300+
	Gerber File
Environmental Rating	ENV120

NOTES

A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuits' applicable established test performance criteria and measurement instructions.
C. The parts covered by this specification document are subject to Mini-Circuits' standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html

Thin-Film Lowpass Filter ALF-7300+

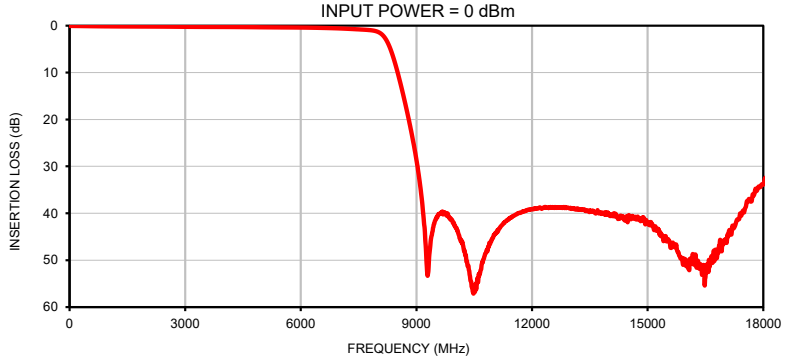
Typical Performance Data

FREQ. (MHz)	Insertion Loss (dB)	Input Return Loss (dB)	Output Return Loss (dB)
10	0.05	43.66	45.83
20	0.05	43.33	44.90
50	0.06	41.27	43.73
100	0.06	39.32	41.75
150	0.07	38.18	40.14
200	0.07	37.35	38.75
250	0.08	36.58	37.56
300	0.08	36.01	36.54
350	0.09	35.58	35.55
400	0.09	35.22	34.74
450	0.10	34.85	33.95
500	0.10	34.59	33.16
550	0.11	34.29	32.53
600	0.12	34.00	31.89
700	0.12	33.33	30.81
800	0.13	32.69	29.97
900	0.14	32.05	29.34
1000	0.15	31.39	28.79
1100	0.15	30.77	28.45
1200	0.16	30.22	28.29
1500	0.17	28.85	28.50
2000	0.19	27.64	31.41
2500	0.21	26.43	29.86
3000	0.24	25.06	25.49
3500	0.27	25.90	24.92
4000	0.28	33.37	28.82
5000	0.34	24.83	25.19
6000	0.40	28.75	28.25
6500	0.47	39.83	35.54
7000	0.59	26.46	25.27
7100	0.62	24.49	23.73
7300	0.70	21.74	21.54
7500	0.79	20.50	20.95
7700	0.88	22.39	23.96
7900	1.07	28.39	28.70
8000	1.32	18.74	18.08
8100	1.84	12.44	12.09
8200	2.82	8.17	8.01
8250	3.55	6.59	6.50
8500	9.60	2.53	2.58
8700	16.27	1.66	1.71
9000	28.62	1.32	1.31
9400	44.64	1.26	1.08
9500	41.25	1.26	1.03
10000	42.63	1.27	0.91
10500	55.79	1.25	0.91
11000	44.85	1.19	1.01
11600	40.20	1.09	1.15
12000	39.12	1.05	1.22
12500	38.76	1.04	1.27
13000	38.83	1.10	1.22
13500	39.42	1.21	1.14
14000	40.21	1.36	1.03
14400	41.51	1.49	0.97
15000	42.14	1.64	0.96
15500	45.82	1.69	1.03
16000	51.30	1.63	1.15
17000	46.10	1.34	1.51
17500	39.84	1.22	1.65
18000	33.88	1.16	1.70

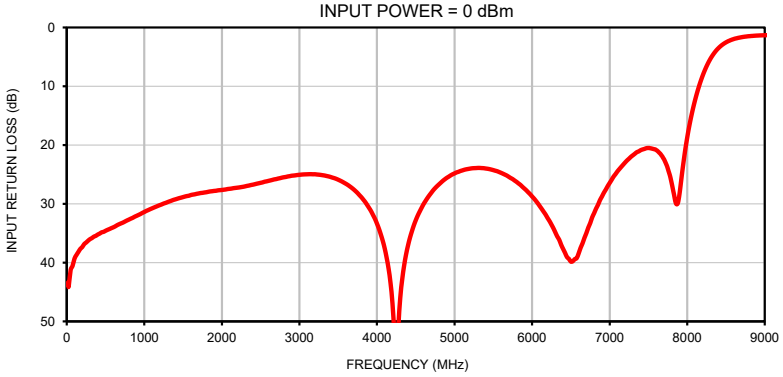
FREQ. (MHz)	Group Delay (ns)
10	0.12
20	0.12
25	0.12
50	0.12
75	0.12
100	0.12
125	0.12
150	0.12
175	0.12
200	0.12
225	0.12
250	0.12
300	0.12
400	0.12
500	0.12
600	0.12
700	0.12
800	0.12
900	0.12
1000	0.12
1100	0.12
1200	0.12
1300	0.12
1400	0.12
1500	0.12
1600	0.12
1700	0.12
1800	0.12
1900	0.12
2000	0.12
2100	0.12
2200	0.12
2300	0.12
2400	0.12
2500	0.12
2600	0.12
2700	0.12
2800	0.12
2900	0.12
3000	0.13
3100	0.13
3200	0.13
3300	0.13
3400	0.13
3500	0.13
3600	0.13
3700	0.13
3800	0.13
3900	0.13
4000	0.13
4500	0.14
5000	0.15
5500	0.16
6000	0.17
6200	0.18
6500	0.19
7000	0.22
7100	0.23
7200	0.24
7300	0.25

Typical Performance Curves

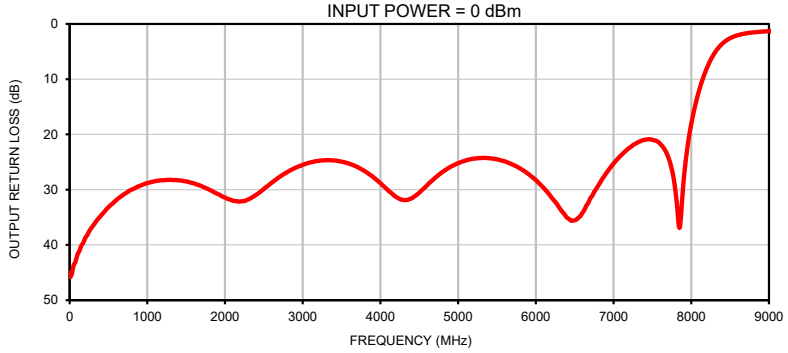
INSERTION LOSS
INPUT POWER = 0 dBm



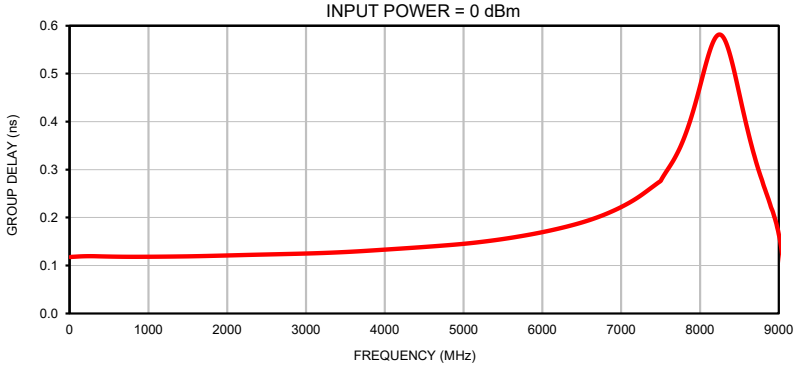
INPUT RETURN LOSS
INPUT POWER = 0 dBm



OUTPUT RETURN LOSS
INPUT POWER = 0 dBm

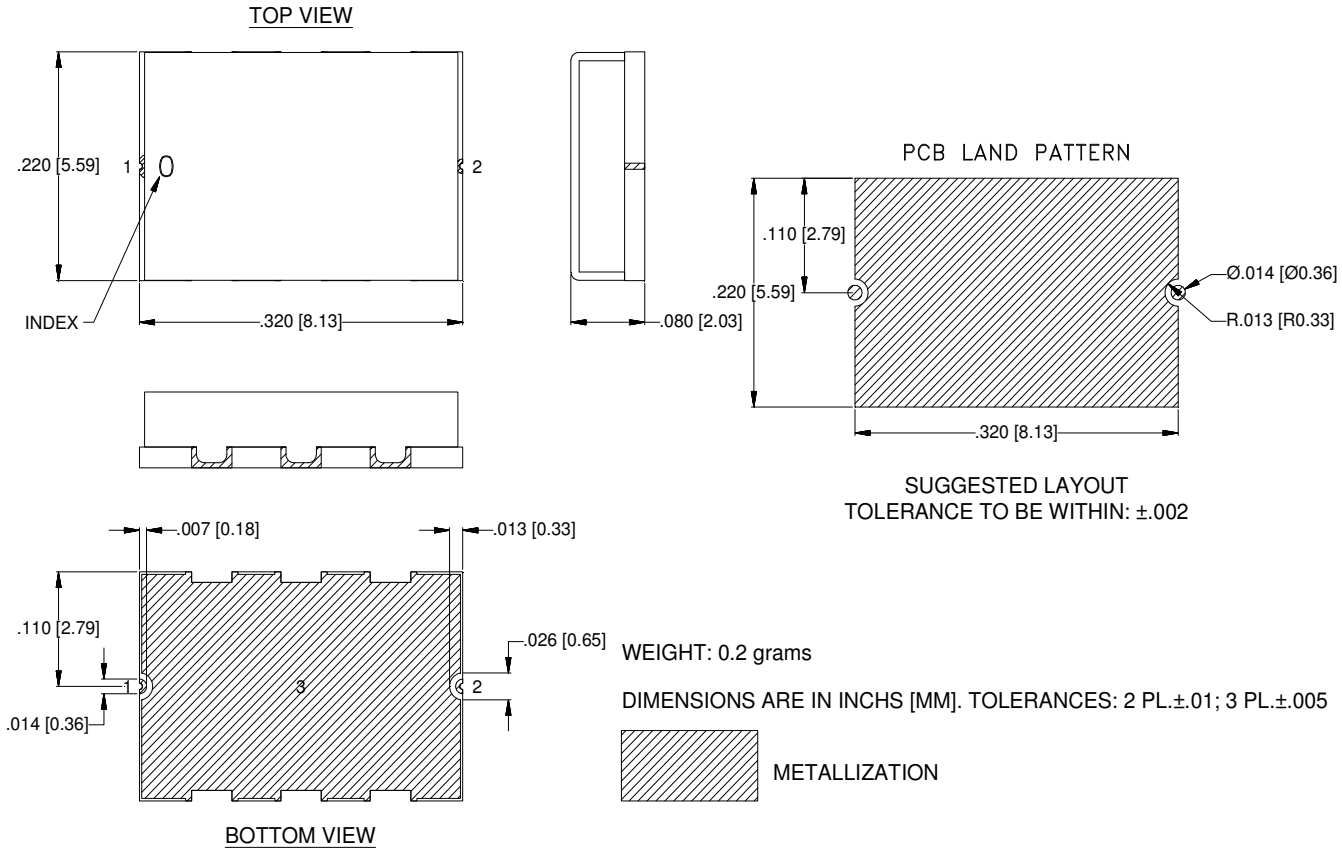


GROUP DELAY
INPUT POWER = 0 dBm



Case Style UC

Outline Dimensions UC2731

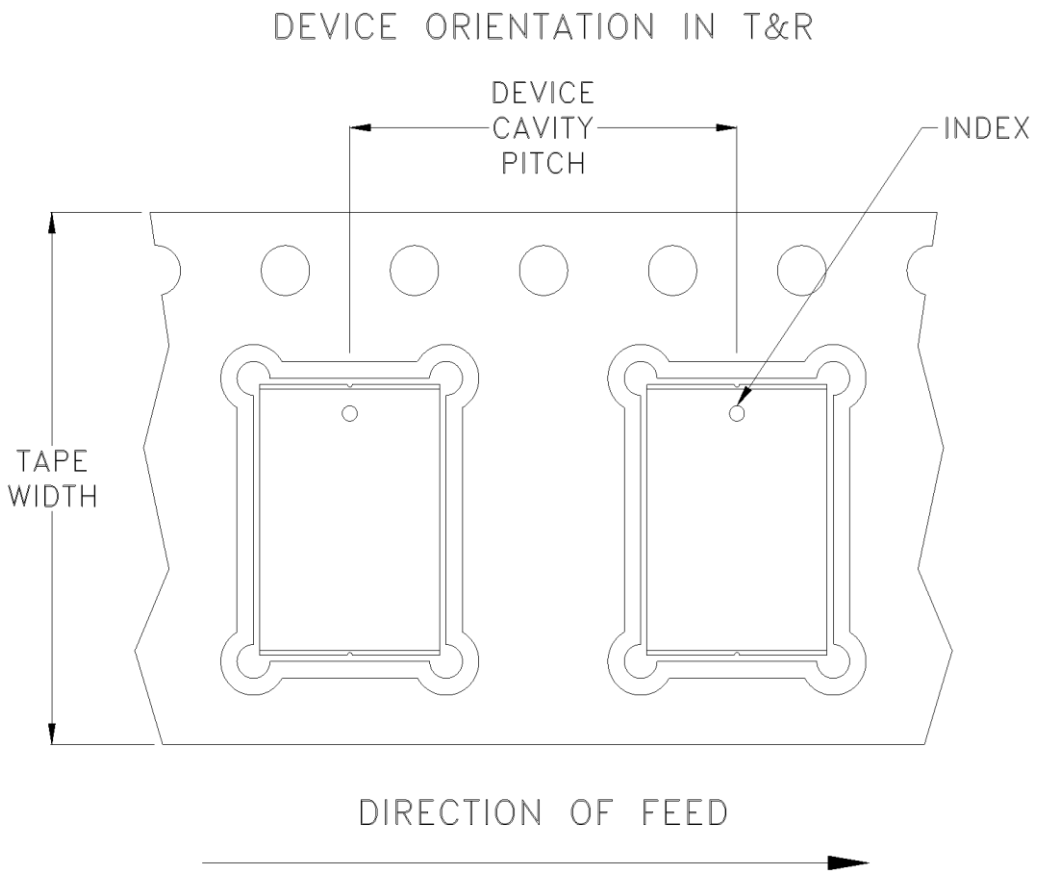


Notes:

1. Case material: Gold over Nickel over Annealed Stainless Steel.
2. Base: Ceramic
3. Termination finish: **as shown below or indicated on Data Sheet.**
   For RoHS Case Styles: Gold over Nickel plate. All models, (+) suffix.

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Tape & Reel Packaging TR-F003



Tape Width, mm	Device Cavity Pitch, mm	Real Size, inches	Devices per Reel See note
16	12	7	10
			20
			50
			100
			200
		13	500

Note: Please consult individual model data sheet/dashboard to determine device per reel availability.

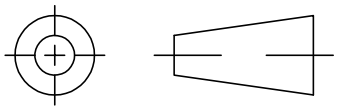
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Go to: www.minicircuits.com/pages/pdfs/tape.pdf

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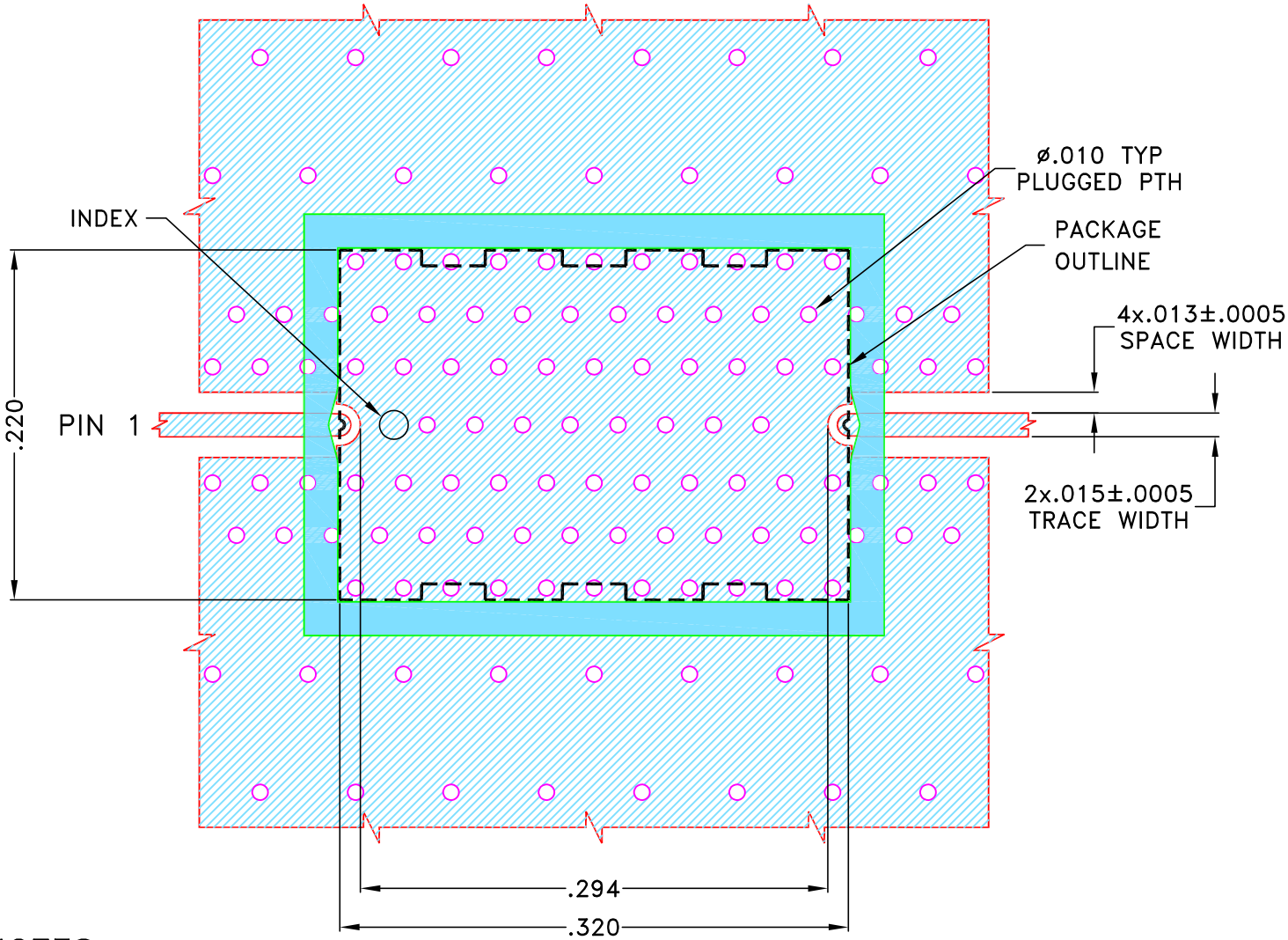
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THIRD ANGLE PROJECTION



REVISIONS					
REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	NPO-003903	NEW RELEASE	OCT 23	LK	VC

SUGGESTED MOUNTING CONFIGURATION FOR UC2731 CASE STYLE



NOTES:

1. COPLANAR WAVEGUIDE PARAMETERS ARE SHOWN FOR ROGERS (RO4350B Lo Pro) WITH DIELECTRIC THICKNESS .0073±.0007. COPPER: 1/2 Oz. EACH SIDE.
   FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER PATTERN WITH SMOBC (SOLDER MASK OVER BARE COPPER)

DENOTES PCB COPPER PATTERN FREE OF SOLDERMASK

UNLESS OTHERWISE SPECIFIED		INITIALS	DATE
DIMENSIONS ARE IN INCHES	DRAWN	LK	09 OCT 23
TOLERANCES ON:	CHECKED	MD	09 OCT 23
2 PL DECIMALS ±	APPROVED	RR	13 OCT 23
3 PL DECIMALS ± .005			
ANGLES ±			
FRACTIONS ±			

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ASHEETA1.DWG REV:A DATE:01/12/95

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Brooklyn NY 11235

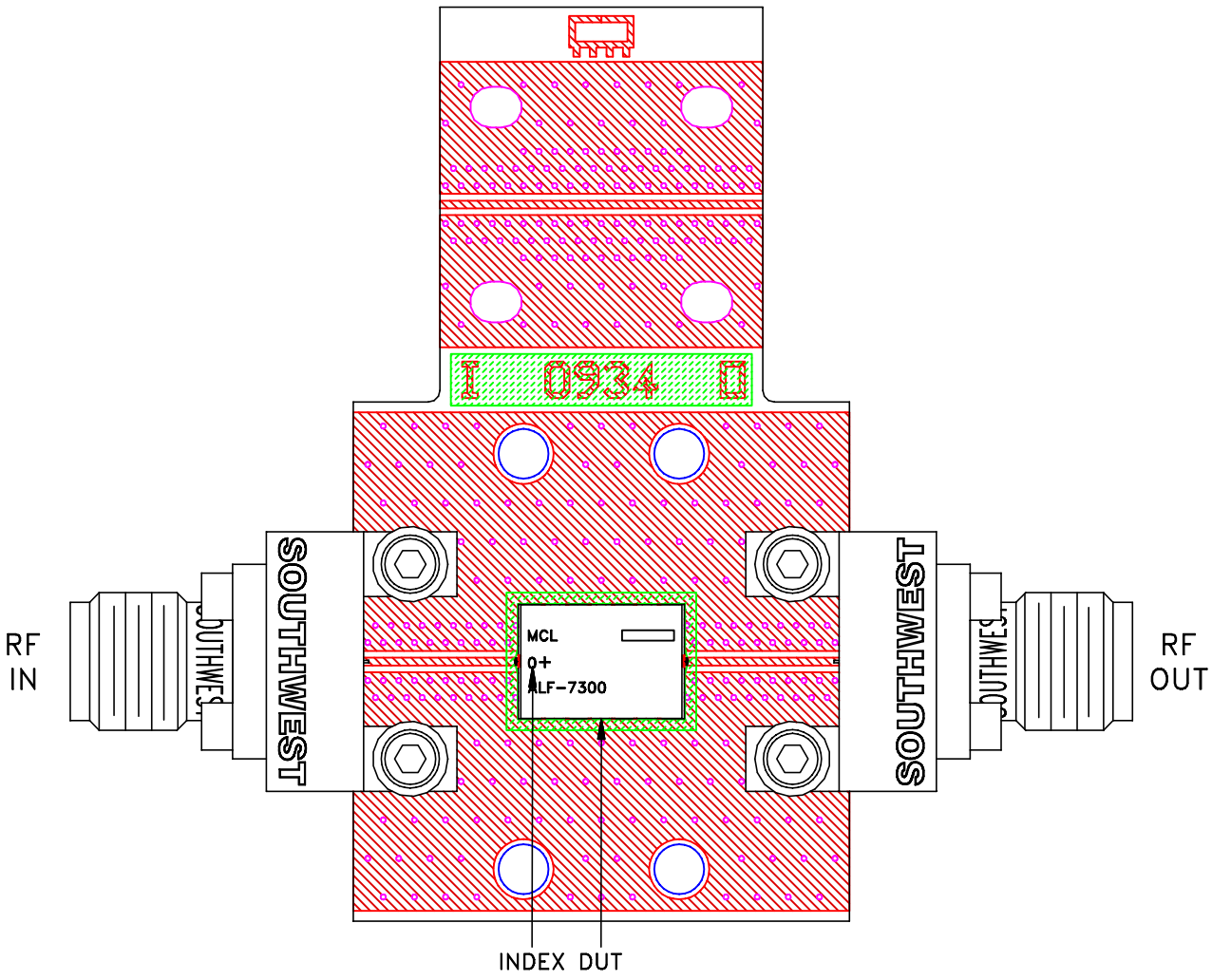
PL DWG, UC2731 C.S, 50 OHM, ALF

SIZE	CODE IDENT	DRAWING NO:	REV:
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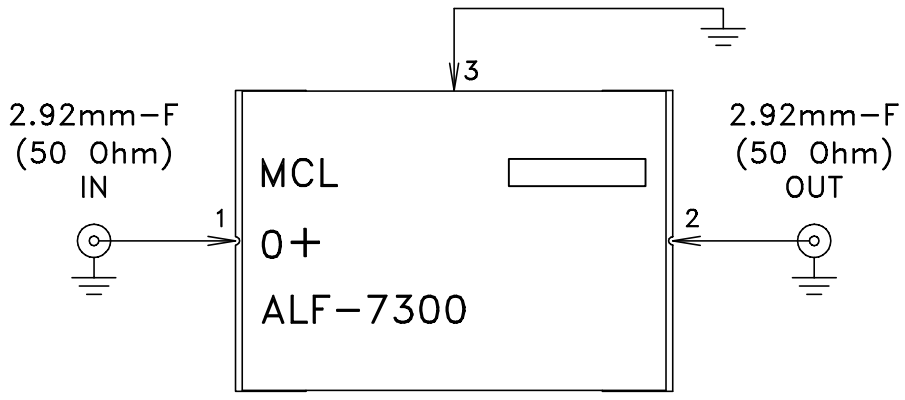
FILE:	SCALE:	SHEET:
98-PL-764	9.1:1	1 OF 1

Evaluation Board and Circuit

TB-ALF-7300+



Schematic diagram



Notes:

1. PCB Material: ROGERS (RO4350B Lo Pro) OR Equivalent, Dielectric Constant=3.48±.05
Dielectric Thickness: .0073±.0007 inch
2. 50 Ohm 2.92mm Female Connectors.

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Mini-Circuits

Environmental Specifications **ENV120**

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Solderability	10X Magnification	J-STD-002, Para 4.2.5, Test S, 95% Coverage
Thermal Shock	-55° to 125°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, Except +125°C

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